



Docket No. IRV1.PAU.30

Patent Application

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:  
Douglas M. Albert  
Volkan H. Ozguz

Examiner: unassigned

Group Art Unit: unassigned

Serial No.: 09/190,378

Filed: November 10, 1998

For: METHOD FOR THINNING  
SEMICONDUCTOR WAFERS  
WITH CIRCUITS AND WAFERS  
MADE BY THE SAME

Costa Mesa, California

March 28, 2000

#5/a  
8-31-00  
Payton

PRELIMINARY AMENDMENT

AND REQUEST FOR INTERFERENCE WITH A PATENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

Dear Sir:

Prior to an examination on the merits in the above-entitled continuation application, please enter the following amendments and consider the following remarks.

IN THE SPECIFICATION

On page 7, line 2, before "wafer" please insert --the--;

On page 9, line 16, after "are" please delete "choosing" and insert --chosen--;

On page 10, line 9, after "24" please delete "is" and insert --may be--;

On page 11, line 8, after "layer" please delete "24" and insert --26--;

On page 11, line 13, after "wafer" please delete "22" and insert --20 and--;

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01 FC:202  
02 FC:203

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45.00 OP